		lication Fee					
Application Number:	105	10555899					
Filing Date:	04-	04-Dec-2006					
Title of Invention:		MICROELECTRONIC SUBSTRATES WITH THERMALLY CONDUCTIVE PATHWAY AND METHODS OF MAKING SAME					
First Named Inventor/Applicant Name:	Ber	Benny H. Johnson					
Filer:	Do	Don V. Kelly/Christina Edwards					
Attorney Docket Number:	313	313688001US1					
Filed as Large Entity	•						
U.S. National Stage under 35 USC 371	Filing Fee	,					
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							

Publ. Fee- early, voluntary, or normal

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
	Total in USD (\$)			1810